DB3S308F

Silicon epitaxial planar type

For high speed switching circuits

Features

- Short reverse recovery time t_{rr}
- Low forward voltage V_F
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL: Level 1 compliant)
- Marking Symbol: 4T

Basic Part Number

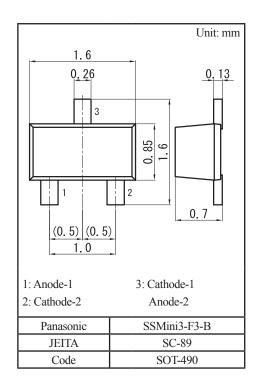
Dual DB2S308 (Series)

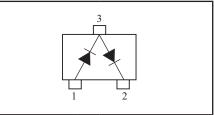
Packaging

DB3S308F0L Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)

Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit		
Reverse voltage		V _R	30	V	
Repetitive peak reverse voltage		V _{RRM}	30	V	
Forward current (Average)	Single	т	100	mA	
	Series	I _{F(AV)}	75		
Peak forward current	Single	т	200	mA	
	Series	I _{FM}	150		
Non-repetitive peak forward surge current *1		I _{FSM}	1	А	
Junction temperature		T _j 125		°C	
Operating ambient temperature		T _{opr}	T _{opr} -40 to +85		
Storage temperature		T _{stg}	-55 to +125	°C	





Note) *1: 50 Hz sine wave 1 cycle (Non-repetitive peak current)

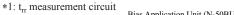
Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

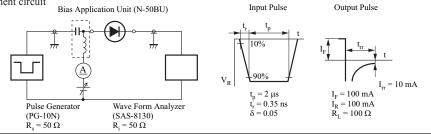
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V _{F1}	$I_F = 10 \text{ mA}$			0.29	V
	V _{F2}	$I_F = 100 \text{ mA}$			0.42	
Reverse current	I _{R1}	$V_R = 10 V$			25	μA
	I _{R2}	$V_R = 30 V$			120	
Terminal capacitance	Ct	$V_{R} = 10 V, f = 1 MHz$		2.9		pF
Reverse recovery time *1	t _{rr}	$I_F = I_R = 100 \text{ mA}, I_{rr} = 10 \text{ mA}, R_L = 100 \Omega$		1.3		ns

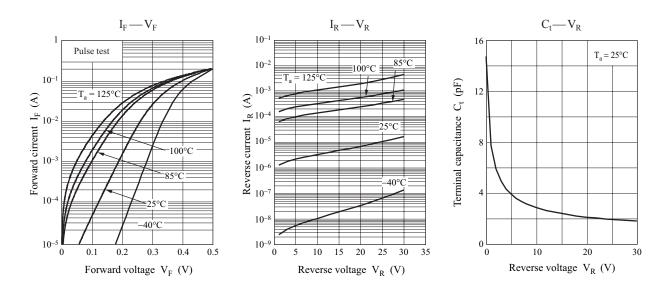
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.

3. Absolute frequency of input and output is 250 $\rm MHz$

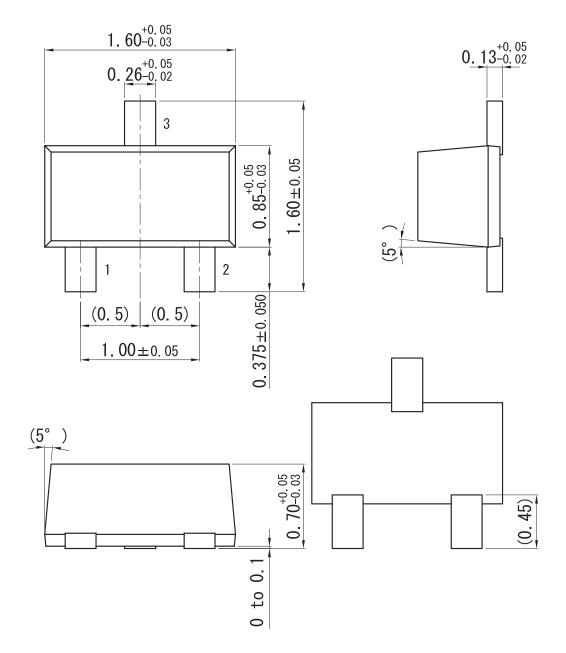




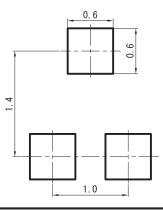


SSMini3-F3-B

Unit: mm



Land Pattern (Reference) (Unit: mm)



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